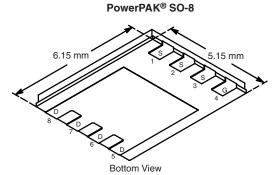


Vishay Siliconix

N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
40	0.005 at V _{GS} = 10 V	40	24			
	0.006 at V_{GS} = 4.5 V	40	24			



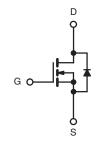
Ordering Information: SiR418DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- Q_a Optimized
- 100 % R_g Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Conversion
- Industrial



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		40 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		40 ^a		
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	23.5 ^{b, c}		
	T _A = 70 °C		18.8 ^{b, c}	•	
Pulsed Drain Current		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		35		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.5 ^{b, c}		
Avalanche Current L = 0.1 mH Single-Pulse Avalanche Energy L = 0.1 mH		I _{AS}	30		
		E _{AS}	45	mJ	
	T _C = 25 °C		39		
Maximum Power Dissipation	T _C = 70 °C	P _D	25	w	
Maximum Power Dissipation	T _A = 25 °C	'D	5 ^{b, c}	VV	
	T _A = 70 °C		3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		
Soldering Recommendations (Peak Temperature) ^{d, e}			260	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical Maximum		Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	2.1	3.2		
Notes:						

a. Based on T_C = 25 °C. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (www.vishav.com/doc?73461). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 70 °C/W.

FREE

SiR418DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 1 μA to 250 μA		48		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{\rm D} = 1 \mu A 10 250 \mu A$		- 5.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.1		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS} = 40$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	_	V _{GS} = 10 V, I _D = 20 A		0.00415	0.005		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 15 A		0.0048	0.006	Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 20 A		95		S	
Dynamic ^b	010						
Input Capacitance	C _{iss}			2410		pF	
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		371			
Reverse Transfer Capacitance	C _{rss}			141			
· · · · · · · · · · · · · · · · · · ·		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		50	75		
Total Gate Charge	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		24	36	nC	
Gate-Source Charge	Q _{gs}			6.5			
Gate-Drain Charge	Q _{gd}			7.0			
Gate Resistance	R _g	f = 1 MHz	0.2	0.7	1.4	Ω	
Turn-On Delay Time	t _{d(on)}			19	35		
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$		73	140	- - - ns -	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{q}} = 1 \Omega$		32	60		
Fall Time	t _f	Ŭ		12	24		
Turn-On Delay Time	t _{d(on)}			9	18		
Rise Time	t _r	$V_{DD} = 20 V, R_1 = 2 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		25	45		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteristi							
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			35		
Pulse Diode Forward Current ^a	I _{SM}				70	A	
Body Diode Voltage	V _{SD}	I _S = 4 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}	<u> </u>		24	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			15	30	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		13			
Reverse Recovery Rise Time	ta t _b	-		10		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

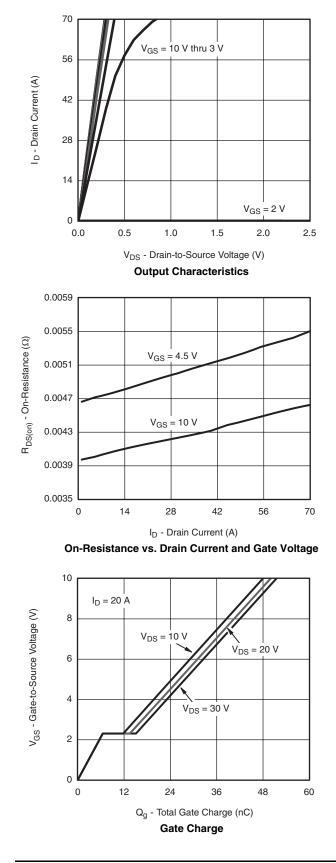
b. Guaranteed by design, not subject to production testing.

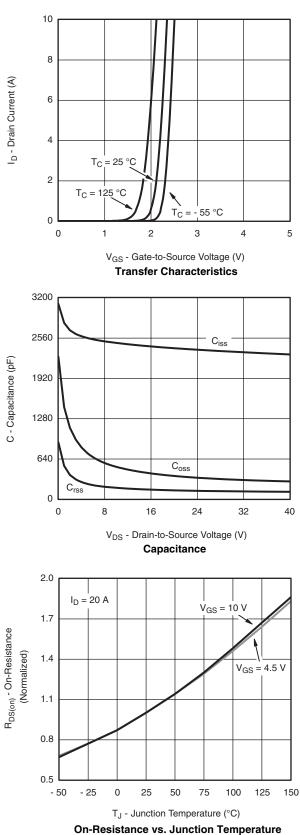
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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 $I_{\rm D} = 20 \, {\rm A}$

 $T_J = 125 \ ^\circ C$

T_J = 25 °C

10

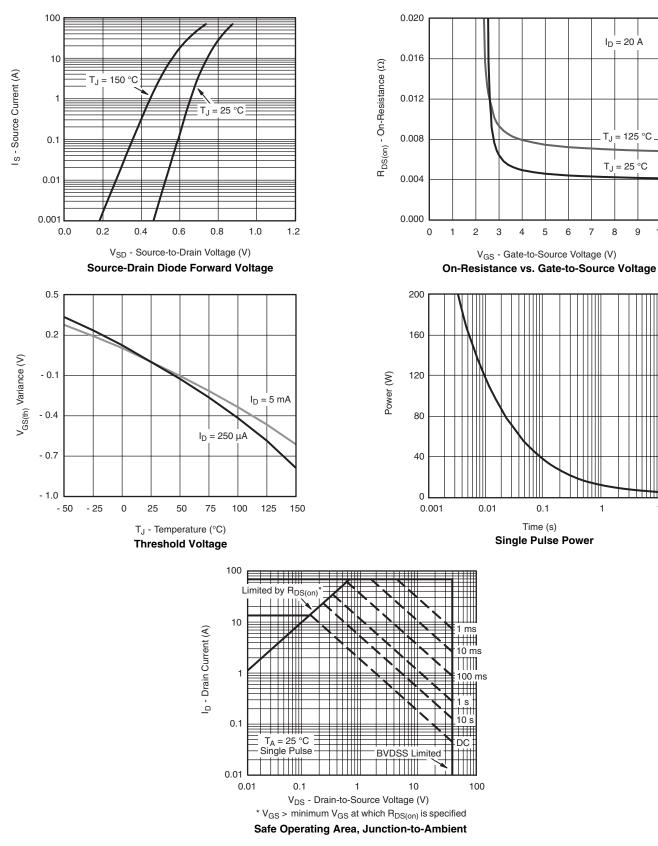
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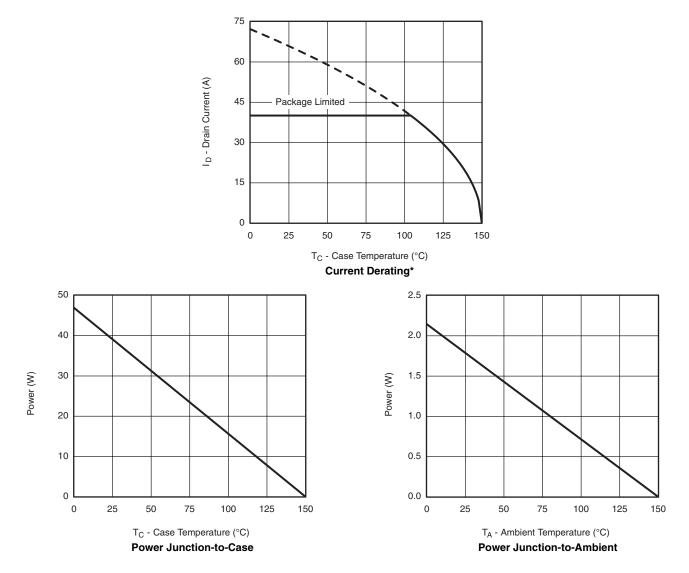
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







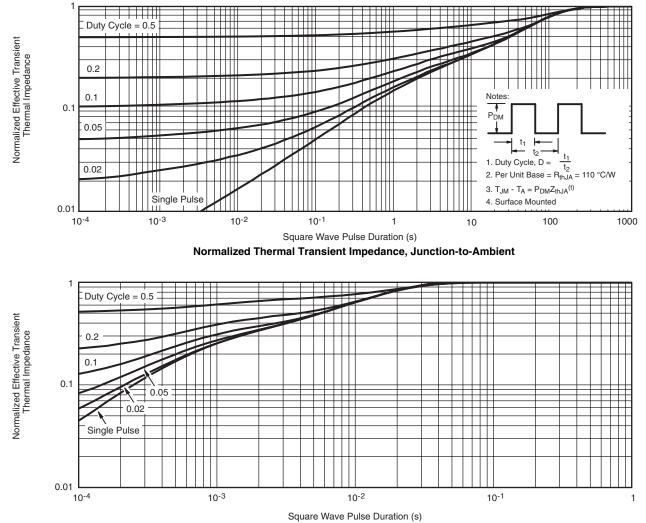
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65153.



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